PAGE 1 SHARP PATENTS FAX: 13608178505 AMENDMENT TRANSMITTAL LETTER (Large Entity) Docket No. Applicant(s): Wei Pan, Yoshi Ono, David R. Evans and Sheng Teng SLA0515 Serial No Filing Date Examiner Group Art Unit 09/819,296 March 27, 2001 Hung K, Vu 2811 Invention: Multi-Layered Barrier Metal Thin Films for Cu Interconnect By ALCVD TO THE COMMISSIONER FOR PATENTS: Transmitted herewith is an amendment in the above identified application. The fee has been calculated and is transmitted as shown below. **CLAIMS AS AMENDED CLAIMS REMAINING HIGHEST#** NUMBER OF EXTRA **ADDITIONAL** RATE AFTER AMENDMENT PREV. PAID FOR CLAIMS PRESENT FEE TOTAL CLAIMS 17 20 = x \$18.00 \$0.00 INDEP, CLAIMS 3 3 = 0 x \$84.00 \$0.00 Multiple Dependent Claims (check if applicable) \$0.00 TOTAL ADDITIONAL FEE FOR THIS AMENDMENT \$0.00 **FAX COPY RECEIVED** <u>x</u> No additional fee is required for amendment. OCT 0 7 2002 Please charge Deposit Account No. 19-1457 in the amount of \$0.00. A duplicate copy of this sheet is enclosed. TECHNOLOGY CENTER 2800 A check in the amount of to cover the filing fee is enclosed. The Commissioner is hereby authorized to charge payment of the following fees associated with this _X_ communication or credit any overpayment to Deposit Account No. . 19-1457. A-duplicate copy of this/sheet is enclosed. Any additional fées required under 37 C.F.R. 1.16. Any/patent application processing fees under 37 C.F.R. 1.17. _X_ Dated: OCTOBER 7, 2002 Rayid C. Ripma, Reg. No. 27,672 I hereby certify that this correspondence is being facsimile transmitted to the nited States Patentiand Trademark Office under 37 C.F.R. §1.8 at Fax No. (703) 872-9318 on October 7, 2002. David C. Ripina, Reg. No. 27,672 Note: Each paper must have its own certificate or transmission, or this certificate must identify each submitted paper. The papers submitted include: X This Amendment Transmittal Letter (Duplicate Attached) 2 page(s) x Response under 37 CFR § 1.111 page(s) Attachmenta page(s) * Petition for Extension of Time under 37 C.F.R. § 1.136 (Duplicate Attached) 2 page

Total pages, including this Transmittal:

23

FAX: 13608178505

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)	PATENT APPLICATION	
Inventors:	Wei Pan, Yoshi Ono, David R. Evans and Sheng Teng Hsu))))	Attorney Docket No. SLA0515	6/a FJONES 10-23-02
Serial No.:	09/819,296)	October 7, 2002	10-23-02
Filed:	March 27, 2001)	a	
en)	Group Art Unit 2811	
Title:	MULTI-LAYERED)		
	BARRIER METAL)	Examiner: Vu, Hung K.	
	THIN FILMS FOR Cu)	· -	
	INTERCONNECT)		
	BY ALCVD			

RESPONSE UNDER 37 C.F.R. § 1.111

Hon. Commissioner for Patents Washington, D.C. 20231

Sir:

In response to an Office Action dated June 5, 2002, please amend the above-identified application as follows.

In the Claims:

Please cancel claims 1-7 and 11.

Please amend claims 8, 10, 12 and 14.

Please add new claims 21-25 as follows.

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TECHNOLOGY CENTER 2800

A clean version of the amended claims is shown on the following sheet(s), and a marked-up version, showing the changes made, is being submitted as Appendix A to this Amendment, pursuant to the amendment practice as specified in 37 C.F.R. section 1.121. Appendix B to this Amendment includes a copy of each currently pending claim in the application, including claims newly added and amended by this Response.

1 AmSLA0515 SI-A0515 Amendment